

PRELIMINARY

Notice: This is not a final specification.
Some parametric limits are subject to change.

MITSUBISHI SEMICONDUCTOR <GaAs FET>

MGFC39V5964A

5.9~6.4GHz BAND 8W INTERNALLY MATCHED GaAs FET

DESCRIPTION

The MGFC39V5964A is an internally impedance-matched GaAs power FET especially designed for use in 5.9~6.4 GHz band amplifiers. The hermetically sealed metal-ceramic package guarantees high reliability.

FEATURES

- Class A operation
- Internally matched to 50Ω system
- High output power
 $P_{1dB} = 8W$ (TYP) @ 5.9~6.4GHz
- High power gain
 $G_{LP} = 9$ dB (TYP) @ 5.9~6.4GHz
- High power added efficiency
 $\eta_{add} = 30\%$ (TYP) @ 5.9~6.4GHz, P_{1dB}
- Hermetically sealed metal-ceramic package
- Low distortion [Item: -51]
 $IM_3 = -45$ dBc (TYP) @ $P_o = 28$ (dBm) S.C.L.

APPLICATION

- Item-01: 5.9~6.4GHz band power amplifier
- Item-51: Digital radio communication

QUALITY GRADE

- IG

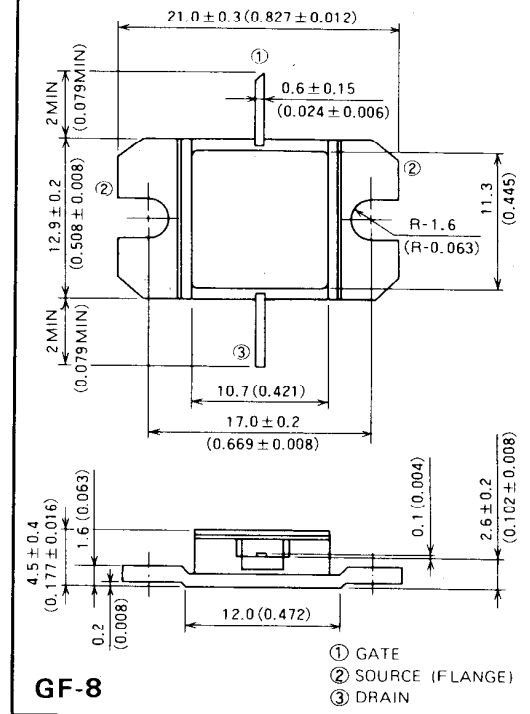
ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

| Symbol | Parameter | Ratings | Unit |
|------------------|----------------------------|------------|------|
| V _{GDO} | Gate to drain voltage | -15 | V |
| V _{GSO} | Gate to source voltage | -15 | V |
| I _D | Drain current | 7.5 | A |
| I _{GR} | Reverse gate current | -20 | mA |
| I _{GF} | Forward gate current | 42 | mA |
| P _T | Total power dissipation *1 | 42.8 | W |
| T _{ch} | Channel temperature | 175 | °C |
| T _{stg} | Storage temperature | -65 ~ +175 | °C |

*1: T_c = 25°C

OUTLINE DRAWING

Unit: millimeters (inches)



RECOMMENDED BIAS CONDITIONS

- V_{DS} = 10V
- I_D = 2.4A
- R_g = 50Ω
- Refer to Bias Procedure

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

| Symbol | Parameter | Test conditions | Limits | | | Unit | |
|-----------------------|--------------------------------------|--|------------------------|-----|------|------|------|
| | | | Min | Typ | Max | | |
| I _{DSS} | Saturated drain current | V _{DS} = 3V, V _{GS} = 0V | — | — | 7.5 | A | |
| g _m | Transconductance | V _{DS} = 3V, I _D = 2.2A | — | 2 | — | S | |
| V _{GS(off)} | Gate to source cut-off voltage | V _{DS} = 3V, I _D = 20mA | — | — | -4.5 | V | |
| P _{1dB} | Output power at 1dB gain compression | V _{DS} = 10V, I _D = 2.4A, f = 5.9~6.4GHz | 38 | 39 | — | dBm | |
| G _{LP} | Linear power gain | | 8 | 9 | — | dB | |
| I _D | Drain current | | — | — | 3.0 | A | |
| η _{add} | Power added efficiency | | — | 30 | — | % | |
| IM ₃ | 3rd order IM distortion *1 | | -42 | -45 | — | dBc | |
| R _{th(ch-c)} | Thermal resistance *2 | | ΔV _f method | — | — | 3.5 | °C/W |

*1: Item-51, 2-tone test. P_o = 28 dBm Single Carrier Level. f = 6.4GHz. Δf = 10 MHz. *2: Channel to case

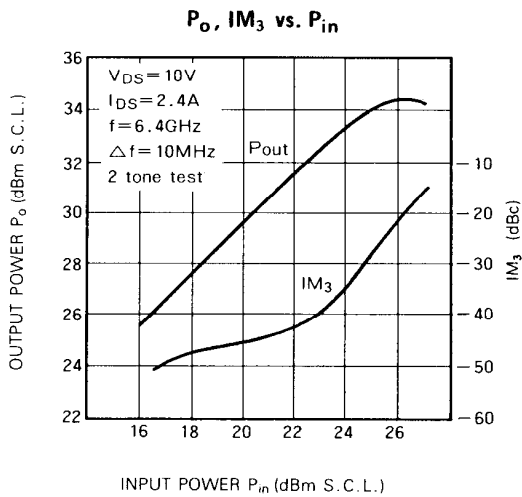
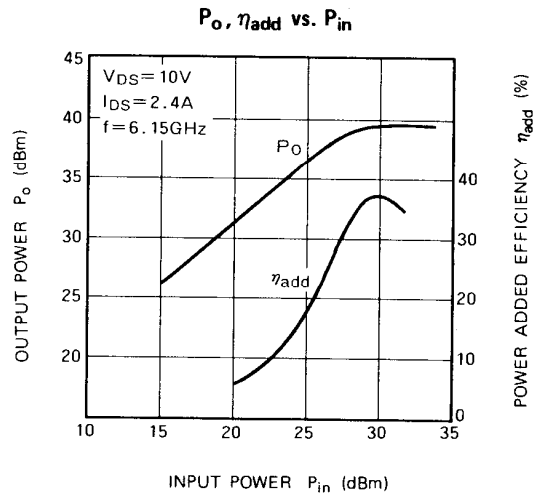
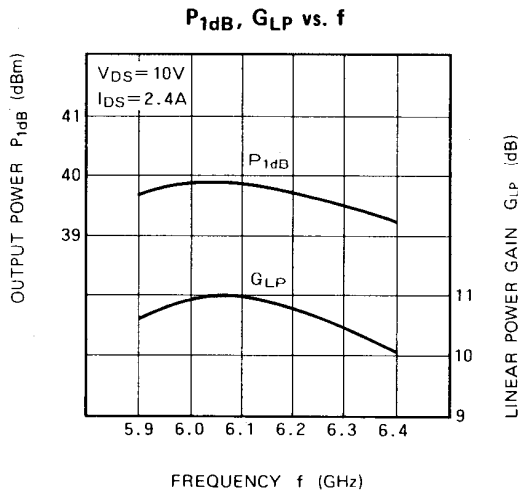
NOV. '97

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TYPICAL CHARACTERISTICS (Ta=25°C)



S PARAMETERS (Ta=25°C, V_{DS}=10V, I_{DS}=2.4A)

| f (GHz) | S Parameters (TYP.) | | | | | | | |
|------------|---------------------|--------------|-----------------|--------------|-----------------|--------------|-----------------|--------------|
| | S ₁₁ | | S ₂₁ | | S ₁₂ | | S ₂₂ | |
| | Magn. | Angle (deg.) | Magn. | Angle (deg.) | Magn. | Angle (deg.) | Magn. | Angle (deg.) |
| 5.9 | 0.32 | -171 | 3.388 | -23 | 0.079 | -76 | 0.18 | 168 |
| 6.0 | 0.23 | 156 | 3.516 | -41 | 0.084 | -93 | 0.14 | 141 |
| 6.1 | 0.18 | 106 | 3.548 | -58 | 0.088 | -111 | 0.13 | 109 |
| 6.2 | 0.21 | 56 | 3.479 | -75 | 0.089 | -128 | 0.13 | 73 |
| 6.3 | 0.29 | 23 | 3.330 | -92 | 0.087 | -145 | 0.14 | 43 |
| 6.4 | 0.38 | 2 | 3.170 | -108 | 0.086 | -160 | 0.15 | 23 |